

M33G

GSM / GPRS Wireless Module

Datasheet

Rev. 1.0.3 2009/07/23

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Module Business Division Mobile Communications BU Qisda Corporation

18 Jihu Road, Nei-Hu, Taipei 114, Taiwan

Tel: +886-2-2799-8800 Fax: +886-2-2799-8332

http://Qisda.com



Date	Originator	Reviewer
12-SEP-2008	C.K. Wang	

History

Version	Date	Notes			
VER: 1.0.0	12-SEP-2008	First Release			
VER: 1.0.1	13-FEB-2009	Added Vbackup pin			
		Removed keypad interrupt			
VER: 1.0.2	14-APR-2009	Modified PCB layout recommendation			
		Removed Vbackup			
VER: 1.0.3	23-JUL-2009	Updated power consumption data			



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1. INTRODUCTION

1.1. DESCRIPTION

Overview

The document describes all the functions, features, and interfaces of the GSM/GPRS Dual band Module M33 from Qisda. The M33 GSM/GPRS module can provide wireless communication solution for any product that has requirement of voice communication and data transmission through state of the art cellular technology.

With the QISDA M33 GSM/GPRS module, devices are enhanced in both functionality and usability based on state of the art wireless technology.

1.2. APPLICATION DEVICE

This module is designed to satisfy manufacturers, which also have a physical dimension concern of embedded GSM/GPRS features built into their products. Some main application devices of this module are:

- Telematics
- Wireless Terminal
- Alarm/Securities System
- Automatic Meter Reading
- Remote control
- Mobile Trunk
- Wireless PSTN



2. Features

2.1. General Characteristics

BAND: EGSM 900/DCS 1800

	TX	RX
EGSM	880~915 MHz	925~960MHz
DCS	1710~1785MHz	1805~1880MHz

- GSM/GPRS: Phase 2+ Compliance
 - i. GPRS Class 10: Max 4 downlink, 2 uplink, max 5 slot
 - ii. GPRS Class B:

Simultaneous

- attach
- activation
- monitor

No simultaneous traffic.

- iii. Coding Scheme:
 - CS1 9.05 kbps
 - CS2 13.4 kbps
 - CS3 15.6 kbps
 - CS4 21.4 kbps
- Support SIM Interface: 3V
- Form factor

i. Dimension: 55.5 x 40 x 5.5 mm

ii. Weight: 13 g

Power

Operation Voltage: 3.3V - 4.2V

• Power Consumption:

Speech Mode: 165 mA (min), 280 mA (max)

Standby Mode: < 5 mA (paging rate 2),< 3 mA (paging rate 9) at GSM 900MHz GPRS: 250 mA (class 8, average); 380 mA (class 10, average)at GSM 900MHz

• Hardware Output:

44 Pins female connector interface.

— UART/RS232 RS232 Transmit Interface

USB Software DebugRESET Hardware Reset

— GPIO General Purpose I/O



— Power On Power On Pin

LED Driver, Paging

— SIM SIM Function

VBAT
 Battery Voltage Input

Audio Earphone/MIC/Hand free

— BGND GND

— ANT Antenna Pad

Software Interface:

GSM Rec. 27.07

- General
- Call Control
- Network Service
- ME Control and Status
- ME Errors
- TIA IS-101

GSM Rec. 27.05

- SMS related services
- General Configuration
- Message Configuration
- Message Receiving and Reading
- Message Sending and Writing

ITU-T Rec. V25ter

- General TA Control
- Call Control and Command Response
- Data Compression

ITU-T Rec. T.32

- Action Command
- DCE Response
- Service Command

Note: For software AT commands, please refer to the M33 AT Command List.



2.2. Voice/Data Service

Tele Service

- Speech Service With EFR (Enhance Full Rate)/FR (Full Rate)/HR (Half Rate)/ AMR (Adaptive Multi-rate) Codec.
- Emergency Call
- DTMF Tone Generation

Short Message Service

- SMS with MT (Mobile Terminate)/PP, MO (Mobile Originated)/PP
- Delivery Report
- Cell Broadcast

FAX Service

- Direction: MOC (Mobile originated call) & MTC (Mobile terminated call)
- Fax GSM TS 3.45 fax transparent mode
- TS 61, 62
- TIA/EIA 578, Fax class 1, Interface to PC for GSM & PSTN
- TIA/EIA 592, Fax class 2, Interface to PC for PSTN
- ITU-T V.17 (14400 bps), V29 (9600bps), V27ter (2400/4800 bps)
- Transmission speed rate: 2400, 4800, 7200, 9600bps

Circuit Switch

- Data GSM TS 4.21 transparent mode
- Data GSM TS4.22 transparent mode
- Data transmission mode: asynchronous (normal)
- Radio channel: full rate
- Transmission speed rate: 2400, 4800, 9600 bps with data compression max 14400bps

Packet Switch

- GPRS Class B device
- Multi-Slot Transmission up to Class 10, 2 uplink slot, 4 downlink slot
- Coding Scheme CS1 CS4 Supported

TCP/IP (M2M)

- TCP/IP client to a specific TCP/UDP server
- Machine-to-machine connection over GPRS

STK Parsing

Parse STK raw data to specific data fields



2.3. Supplementary Service

Number identification

- Calling line identification presentation (CLIP)
- Calling line identification restriction (CLIR)
- Connected line identification presentation (CoLP)
- Connected line identification restriction (CoLR)

Call Offering

- Call forwarding unconditional (CFU)
- Call forwarding on mobile subscriber busy (CFB)
- Call forwarding on no reply (CFNRy)
- Call forwarding on mobile subscriber not reachable (CFNRc)

Call Completion

- Call waiting (CW)
- Call hold (HOLD)

Multi-Party

MPTY Supported

Call-barring

- Barring of all outgoing calls (BAOC)
- Barring of outgoing international calls (BOIC)
- Barring of outgoing international calls (BOIC- xHC)
- Barring of all incoming calls (BAIC)
- Barring of incoming calls when roaming (BIC-Roam)



2.4. RF Functionalities

Maximum TX Power

The performance of the transmitter meets test requirement GSM 11.10 Chapter 13.

Band	Max	Min
EGSM	33 dBm ±2dBm	5 dBm ±5dBm
DCS	30 dBm ±2dBm	0 dBm ±5dBm

Parametric Performance

Tests carried out at -20°C, 25°C and 60°C for each voltage 3.6V, 3.8V and 4.0V. The Measure Peak Phase, RMS Phase, frequency error, power level, and static sensitivity meets GSM 11.10 specifications

Band	Peak Phase Error	RMS Phase Error	
EGSM	<20°	<5°	
DCS	<20°	<5°	

Sensitivity

The performance of the receiver meets test requirement GSM 11.10 Chapter 14.

Band	Typical	Min
EGSM	-110 dBm	-107 dBm
DCS	-110 dBm	-108 dBm

Radio Frequency

Radio Frequency (900 MHz EGSM)		
Frequency Range	TX 880-915 MHz; RX 925-960 MHz	
Channel Spacing	200 KHz	
Number of Channels	124 Carriers x 8 (TDMA)	
Modulation	GMSK	
Duplex Spacing	45 MHz	
Frequency Stability	+/- 0.1 ppm (Uplink TX)	
Power Output	33 dBm Class 8 (2 W peak) – 5 dBm	
Output Impedance	50 Ohm	
Spurious Emission	-36 dBm up to 1 GHz (< -30 dBm > 1 GHz)	
Radio Frequency (1800 MHz)		
Frequency Range	TX 1710-1785 MHz; RX 1805-1880 MHz	
Channel Spacing	200 KHz	
Number of Channels	374 Carriers x 8 (TDMA)	
Modulation	GMSK	
Duplex Spacing	95 MHz	
Frequency Stability	+/- 0.1 ppm (Uplink TX)	
Power Output	30 dBm – 0 dBm	
Output Impedance	50 Ohm	
Spurious Emission	-36 dBm up to 1 GHz (< -30 dBm > 1 GHz)	
	Compatible with phase 2 feature	



3. Hardware Description

3.1. INTERFACE

The function description of the M33 module is illustrated as the following table. The pins of the M33 module support functions like UART, GPIO, AUDIO, SIM ... etc. These features can meet customer design requirement for Car Phone.

44 Pins female connector interface

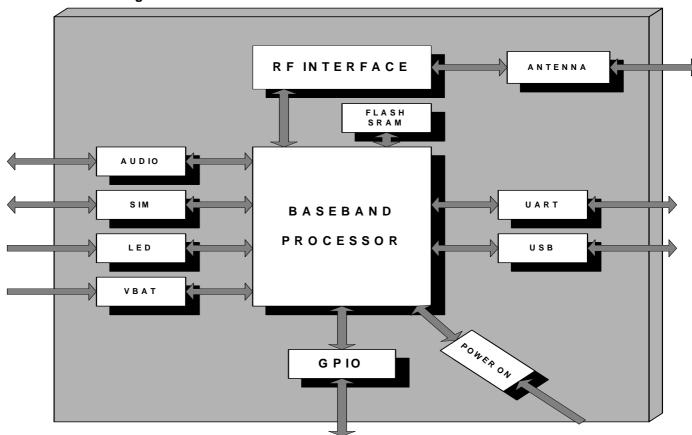
Group	Pin no.	Description
UART/RS232	6	RS232 transmit Interface
USB	3	Software Debug
RESET	1	Hardware Reset
GPIO	6	General Purpose I/O
Power On	1	Power On Pin
LED Driver	1	LED Driver, Paging
SIM	4	SIM Function
VBATRF	3	Power input for RF
VBATBB	1	Power input for BB
Audio	7	Earphone/MIC/Hand Free
NC	1	No connection pin
BGND	10	GND

Antenna interface (MMCX connector)

Group	Pin no.	Description
ANT	1	Antenna interface



3.2. Functional Diagram



3.3. Pin Description

Description Table

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Pin	Description	I/O	Config						
BGND	Description I/O PU Reset Ground								
IO 10	M33 wake up External device O Input					Outp	ut / 0		
ON nOFF							Input		
PWON	Power On	I	PU	Input	Input				
USD DP	USB Data			,					
USD DM	USB Data								
VBUS	USB VBUS	0		0		()		
IO 12 /	GPIO 12	0		Input		Outp	ut / 0		
DCD		_							
VBATRF	RF PA Power Voltage Input		powe	er	min	Тур	max		
VD/TITE	11 1711 Swel Voltage Input		рош	J 1	3.3	3.8	4.2	V	
TXD	UART1-Transmit Data	0		Output / 1		•	1		
RXD	UART1-Receive Data	I	PU	Input		Inp	out		
RTS	UART1-Request To Send	0		Output / 1		•	1		
CTS	UART1-Clear To Send	I	PD	Input		Inp	out		
DSR	UART1-Data Set Ready	I	PU	Input		Inp	out		
IO8/DTR	GPIO 8/ Data Terminal Ready	0		1		Outp	ut / 0		
TDI	JTAG-Data Input	I	LPU	Input	Input				
IO 13	GPIO 13	I		Output / 1			out		
IO1 / RI	GPIO 1	O Input			Output / 0				
IO 6	Re-download Data path and audio path switch	0		Input		Outp	ut / 1		
	Power off mode switch control signal to open or								
	link the connection between system (Host) and	O Input			Output / 0				
IO 11	module (client).								
10 11	Low:; Connect								
	High: Disconnect								
	Default = Connect (Low)								
HSMIC	Headset Microphone input				Input				
MICIN	Microphone amplifier negative input(-)	!			Input				
MICIP	Microphone amplifier positive input(+)	l			Input				
MICBIAS	Microphone bias supply	power			Output(2v/2.5v)				
EARP	Earphone amplifier positive output(+)	0			Output				
EARN	Earphone amplifier negative output(-)	O Output							
HSOL	Headset amplifier	O Output			•				
SIM_RST	SIM Reset	O 0 Output							
SIM_IO	SIM Input / Output	I/O 0					Output		
SIM_CLK	SIM Clock	0 0		0			tput		
VRSIM	Regulator SIM Output	0					tput		
LEDA	LED Driver, Paging Indicator	I				Inp	out		
VBATBB	System Power Voltage Input	power		er	min 3.3	Тур 3.8	max 4.2	V	

UART/RS232

The UART includes the following additional features

- Hardware flow control (DSR, RTS/CTS)
- Auto-baud rate with the possibility of baud-rates ranging from 1200 to 115.2K bits.

Pin Name	Pin Out	Pull	Reset	Config	Description
TXD	34		1	Output/1	Transmit Data
RXD	33	PU	Input	Input	Receive Data
RTS	32		Output / 1	Output/1	Request to Send
CTS	31	PD	Input	Input	Clear to Send
DSR	30	PU	Input	Input	Data Set Ready
IO 8/DTR	29		1	Output/1	Data Terminal Ready



USB

Used for software debug and download.

Pin Name	Pin Out	Pull	Reset	Config	Description
USB_DP	8			Input/Output	USB data bus (positive terminal)
USB_DM	37			Input/Output	USB data bus (negative terminal)
VBUS	36			Power supply	Power Supply VBUS line

GPIO

The module provides 6 GPIO pins configurable in read or write mode.

Pin Name	Pin Out	Pull	Reset	Config	Description
IO 15	39		Input	Input	General Purpose I/O
IO 1	28		1	Input	General Purpose I/O
IO 7	25		Input	Input	General Purpose I/O
IO 2	27		Input	Input	General Purpose I/O
IO 0 / DCD	9		Input	Input	GPIO12/Data Carrier Detect
IO 37/ RI	24		Input	Input	GPIO1/Ring Indicator

LED Driver

LEDA is dedicated for paging identification.

The initial status is listed as follows:

- i. In the initial mode (no voltage input), this pin will be in HIGH status.
- ii. In standby mode it will be pulled low for **500 ms** and then pulled high for **500 ms**, alternately.
- iii. In active mode (Incoming call) it will be pulled low 125 ms and pull high 125 ms.

Pin Name	Pin Out	Pull	Reset	Config	Description
LEDA	6			Input	LED DRIVER, paging Indicator

Note: 1) The maximum current is 10 mA.

2) The LEDA voltage range is 0.4 V ~ VBATBB

SIM Function

The SIM Card digital interface in ABB insures the translation of logic levels between DBB and SIM Card for the transmission of 3 different signals: a clock signal, derived from a clock elaborated in DBB, to SIM Card (SIM_CLK); a reset signal, from DBB to the SIM Card (SIM_RST); and serial data from DBB to SIM Card (SIM_IO) and vice-versa.

Pin Name	Pin Out	Pull	Reset	Config	Description
SIM_CLK	11		0	Output	SIM Clock
SIM_RST	13		0	Output	SIM Reset
SIM_IO	12		0	Input /Output	SIM Input / Output
VRSIM (3V)	23			Output	Regulator SIM Output

VBAT

The maximum and minimum voltage will be defined in the **Electrical Characteristics Table**.



Pin Name	Pin Out	Pull	Reset	Config	Description
VBATRF	41			Input	RF PA Power Voltage input
VBATRF	42			Input	RF PA Power Voltage input
VBATRF	43			Input	RF PA Power Voltage input
VBATBB	1			Input	System Power Voltage input

Audio Function

There is a choice of differential EAR Phone output and differential Microphone input depending on customers' use. In addition, auxiliary pins can be used for hands-free.

Pin Name	Pin Out	Pull	Reset	Config	Description
EARP	20			Output	Earphone amplifier positive output(+)
EARN	21			Output Earphone amplifier negative output(-)	
MICP	16			Input	Microphone amplifier positive input(+)
MICN	17			Input	Microphone amplifier negative input(-)
HSOL	22			Output	Headset amplifier
HSMIC	18			Input	Headset Microphone input
MICBIAS	15			Output	Microphone bias supply

BGND

Pin Name	Pin Out	Pull	Reset	Config	Description
BGND	2				GND
BGND	3				GND
BGND	4				GND
BGND	5				GND
BGND	10				GND
BGND	19				GND
BGND	26				GND
BGND	35				GND
BGND	40				GND
BGND	44				GND

Power ON

The Power On Pin needs to be pulled low for at least 120ms to operate

Pin Name	Pin Out	Pull	Reset	Config	Description
PWON	38	PU		Input	Power On

Antenna

Pin Name	Pin Out	Pull	Reset	Config Description	
Ant	Antenna Pad				Antenna pad for RF cable soldering



3.4. M33 Terminal Definition

			1
VBATBB	1	44	GND
GND	2	43	VBATRF
GND	3	42	VBATRF
GND	4	41	VBATRF
GND	5	40	GND
LEDA	6	39	IO15
ON_nOFF	7	38	PWON
USB_DP	8	37	USB_DM
IO12 / DCD	9	36	VBUS
GND	10	35	GND
SIM_CLK	11	34	TXD
SIM_IO	12	33	RXD
SIM_RST	13	32	RTS
NC	14	31	стѕ
MICBIAS	15	30	DSR
MICIP	16	29	108
MICIN	17	28	IO1
HSMIC	18	27	IO2
GND	19	26	GND
EARP	20	25	107
EARN	21	24	IO1 / RI
HSOL	22	23	VRSIM



Terminal Signal Table

Signal	Pin N	umber	Signal
VBATTBB	1	44	GND
GND	2	43	VBATTRF
GND	3	42	VBATTRF
GND	4	41	VBATTRF
GND	5	40	GND
LEDA	6	39	GPIO15(LS)
OnnOFF	7	38	PWON
USB_DP	8	37	USB_DM
GPIO0_DCD(LS)	9	36	VBUS
GND	10	35	GND
SIM_CLK	11	34	TXD(LS)
SIM_IO	12	33	RXD(LS)
SIM_RST	13	32	RTS(LS)
NC	14	31	CTS(LS)
MICBIAS	15	30	DSR <mark>(LS)</mark>
MICIP	16	29	DTR(LS)
MICIIN	17	28	GPIO1(LS)
<u>HSMIC</u>	18	27	GPIO2(LS)
GND	19	26	GND
EARP	20	25	GPIO7(LS)
EARN	21	24	RI(LS)
<u>HSOL</u>	22	23	VRSIM



Signal Pins Comparison Table between M23 and M33

M33		M33			
		Pin N	umber		
VBATTBB	VBATTBB	1	44	GND	GND
GND	GND	2	43	VBATTRF	VBATTRF
GND	GND	3	42	VBATTRF	VBATTRF
GND	GND	4	41	VBATTRF	VBATTRF
GND	GND	5	40	GND	GND
LEDA	LEDA	6	39	IO10	GPIO15(LS)
OnnOFF	ROW4	7	38	PWON	PWON
USB_DP	TXD2	8	37	RXD2	USB_DM
GPIO0_DCD(LS)	DCD	9	36	BUZZ	VBUS
GND	GND	10	35	GND	GND
SIM_CLK	SIM_CLK	11	34	TXD	TXD(LS)
SIM_IO	SIM_IO	12	33	RXD	RXD(LS)
SIM_RST	SIM_RST	13	32	RTS	RTS(LS)
NC	NC	14	31	CTS	CTS(LS)
MICBIAS	MICBIAS	15	30	DSR	DSR(LS)
MICIP	MICIP	16	29	DTR	DTR(LS)
MICIIN	MICIIN	17	28	IO13	GPIO1(LS)
<u>HSMIC</u>	AUXI	18	27	IO11	GPIO2(LS)
GND	GND	19	26	GND	GND
EARP	EARP	20	25	IO6	GPIO7(LS)
EARN	EARN	21	24	RI	RI(LS)
<u>HSOL</u>	AUXOP	22	23	VRSIM	VRSIM



Electrical Characteristics

Pin	Function /Name	Description	PARAMETE		ER	ı	Min	Тур	Max	Unit
2	GND	Ground								
1	VBATBB	System power input					3.3	3.8	4.2	V
6	LEDA	LED driver, paging	DIGOUT	Current					10	mA
L	LLD/	LLB driver, paging	Diocoi	Supp	ly voltage				VBATBB	V
				Active mo					10	mA
23	VRSIM	Regulator SIM out-		Sleep mo					1	mA
		put		SIMSEL='0'		+	.65	1.8	1.95	V
				SIMSEL='1' (Default)		2.7	2.85	3	V
						1MF	łz@3V		5MHz@3V	
,,	CIM CLIC	CIM alask	CLKOUT	((Voh)	0.7*	VRSIM			V
11	SIM_CLK	SIM_clock	CLKOUT		()(a))				0.2*VRSIM	V
					(Vol)			_	U.Z VRSIN	
					d Current			2		mA
				((Voh)	0.7*	VRSIM			V
					(VoI)				0.2*VRSIM	V
13	SIM_RST	SIM _reset	DIGOUT	Rate	d Current			2		mA
					(VoI)				0.4	V
				Rate	d Current			2		mA
10	GND	Ground								
22	HSOL	Headset amplifier		Min. output resis	stive load			32		ohms
		·		Max. output capa	citive load				100	pF
19	GND	Ground			Γ		ı		Ī	ı
21	EARN	Earphone amplifier output(-)		output swing 3.9 Vpp			33/120			ohms
20	EARP	Earphone amplifier output(+)	1.5 Vpp/C	Output swing 3.9 Vpp			33/120			ohms
15	MICBIAS	Microphone bias	DC-Power	MICBIAS=0			2			٧
15	WIICDIAG	supply	DC-Fower	MICBIAS=1			2.5			٧
16	MICIP	Microphone amplifier input(+)					32.5			mVrms
		Microphone amplifier		Ref. Level (MI- P-MICIN)			-10			dBm0
17	MICIN	input(-)	Differential	input resistance			100			dBm0
18	HSMIC	Headset Microphone input						78		mVrms
3	GND	Ground	1			1			I	
				(\	/oh)	2	2.24			.,
27	102	GPIO:Input/Output	DIGOUT		Vol)				0.616	V
					current			2		mA
					/oh)	2	2.24			
25	107	GPIO: Input/Output	DIGOUT		Vol)				0.616	V
					l current			2		mA
					/oh)	2	2.24			
24	IO37/RI	GPIO: Input/Output	DIGOUT	(Vol)				0.616	V
				· · ·				2m ^		
		Ī	I I	Rated	l current	I		2mA	ı	



Pin	Function /Name	Description			PARAMETER	Min	Тур	Max	Unit		
26	GND	Ground									
4	GND	Ground									
			DIOIN	/OLIT	(Vih)	1.96		3.3	.,		
28	IO1	GPIO:Input/Output	DIGIN	/001	(ViI)	-0.5		0.84	V		
					(Voh)	2.24			V		
29	DTR	Data Terminal	DIGOUT		(Vol)			0.616	V		
		Ready			Rated current		2		mA		
					(Vih)	1.96		3.3	1117 (
30	DSR	RS232: Data set ready	DIGIN		(Vil)	-0.5		0.84	V		
		RS232: Clear to			(Vih)	1.96		3.3			
31	CTS	send	DIGIN		(Vil)	-0.5		0.84	V		
					(Voh)	2.24		0.01			
32	RTS	RS232: request to	DIGOUT		(Vol)	2.21		0.616	V		
		send			Rated current		4	0.0.0	mA		
					(Vih)	1.96		3.3	1		
33	RXD	RS232: receive data	DIGIN		(Vil)	-0.5		0.84	٧		
					Rated current		1		mA		
					(Voh)	2.24					
34	TXD	RS232: transmit DIGO			DIGOUT		(Vol)	2.21		0.616	V
٠.	.,,,	data	2.000.		Rated current		4	0.010	mA		
35	GND	Ground			reated current				ША		
41		Battery voltage input				3.3	3.8	4.2			
42		Battery voltage input				3.3	3.8	4.2	V		
43		Battery voltage input				3.3	3.8	4.2	1 -		
40		Ground				0.0	0.0	7.2			
44	GND	Ground									
	ONE	<u> </u>			(Voh)	2.24					
9	IO 0 /	GPIO:Input/Output	DIGOUT		(Vol)	2.21		0.616	V		
	DCD	DCD St. 10put output			Rated current		2	0.010	mA		
36	VBUS	USB VBUS power		Supply v	/oltage	2.7	5.0	5.25	V		
30	VBUS	supply		Current		8		60	mA		
37	USB_DM	USB data bus (positive terminal)	DIGI/O	Terminating Port	tion Voltage For Upstream Fac- Pull-Up	3.0	3.3	3.6	V		
		live terminal)			iver Leakage Current	-2		2	μΑ		
8	USB_DP	USB data bus		Terminating Port	tion Voltage For Upstream Fac- Pull-Up	3.0	3.3	3.6	V		
		(negative terminal)			iver Leakage Current	-2		2	μA		
			Power		(Vih)	0.7*VBATBB			-		
38	PWON	POWER ON pin	On input		(ViI)	V.1 VDA100		0.3*VBATBB	1		
				I ow leve	el input voltage VIL	0		0.35			
7	ONnOFF	Hardware Reset	dware Reset		el input voltage VIH	1.2		3.00	V		
			(,5 0.1)	i ligit lev				5.00	}		
39	IO15	GPIO :Input/Output	DIGI/O		(Voh) (Vol)	2.24		0.616	V		
					Rated current		2		mA		
5	GND	Ground			rateu current				шА		



Operating Voltage/Current Characteristics

Parameter [Description	Min	Тур	Max	Unit
Supply Voltage range VBATRF	-	3.3	3.8	4.2	V
Peak VBATRF Current			TBD		Α
Average VBATRF Current		TBD		TBD	mA
Average Standby mode VBATRF current F	Paging Rate 9		TBD		mA
Vih I	High-level input voltage	1.96		3.3	V
Vil L	_ow-level input voltage	-0.5		0.84	V
Voh l-	High-level output voltage	2.24			V
Vol L	_ow-level output voltage			0.616	V
SIM_CLK (Output frequency	1.625		3.25	MHz
VRSIM S	SIMSEL=1	2.7	2.85	3.0	V

Audio Uplink Characteristics

Parameter	Conditions	Min	Тур	Max	Unit
Maximum Input Range	Inputs 3 dBm0 (Maximum digital sample amplitude with PGA		32.5		mVrms
(MICIP-MICIN)	gain set to 0 dB)				
Nominal Ref. Level (MICIP-MICIN)			-10		dBm0
Differential Input Resistance			36		ΚΩ
Micro amplifier gain (MIC)			25.6		dB
DC Level at MICBIAS	MICBIAS=0		2.0		Volt
Current Capability at MICBIAS		0		2	mA

Audio Downlink Characteristics

Parameter	Conditions	Min	Тур	Max	Unit
Differential Minimum Resistive load at EARP-EARN	Output swing 3.9 Vpp		120		Ω
	Output swing 1.5 Vpp		33		Ω
Differential Maximum Resistive load at EARP-EARN				100	pF
Common Mode Minimum Resistive load at EARP-EARN			200		ΚΩ
Common Mode Maximum Resistive load at EARP-EARN				50	pF

Global Characteristics

Parameter	Conditions	Min	Тур	Max	Unit
Maximum Output Swing	5% distortion and $120Ω$	3.1	3.92		Vpp
EARP – EARN	5% distortion and 33 $Ω$	1.2	1.5		Vpp
Earphone amplifier gain			1		dB
Earphone amplifier state in power down			Hi-Z		
Power Supply Rejection			40		dB



3.5. M33 Current Consumption

Power off Current

Module power off	50.190uA
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Standby Current

Frequency Band (MHz)	DRX2 (mA)	DRX5 (mA)	DRX9 (mA)
900	4.235	2.759	2.321

Talking Current And GPRS Data Transferring Current

GSM 850MHz/ GSM 900MHz			
Mode	GSM Call	GPRS Class 8	GPRS Class 10
Time slot configuration	1 Up / 1 Down	1 Up / 4 Down	2 Up / 3 Down
Maximum RF output power	33 dBm	33 dBm	33 dBm
Maximum burst current	1.3A	1.3A	1.4A
Average current	206mA	248mA	380mA
DCS 1800MHz/ PCS 1900MHz			
Mode	GSM Call	GPRS Class 8	GPRS Class 10
Time slot configuration	1 Up / 1 Down	1 Up / 4 Down	2 Up / 3 Down
Maximum RF output power	30 dBm	30 dBm	30 dBm
Maximum burst current	0.9A	0.9A	1.0A
Average current	164mA	207mA	292mA

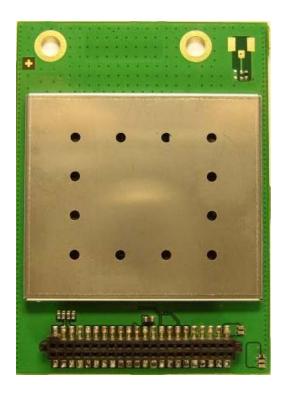
3.6. Environmental

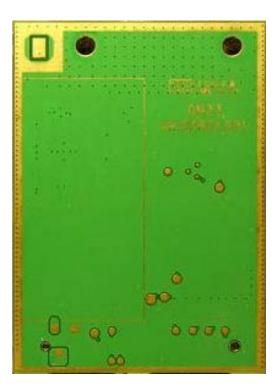
Operational temperature : -20 \sim +60 $^{\circ}$ C Functional temperature : -20 \sim +70 $^{\circ}$ C Storage temperature : -40 \sim +85 $^{\circ}$ C



3.7. Physical Package

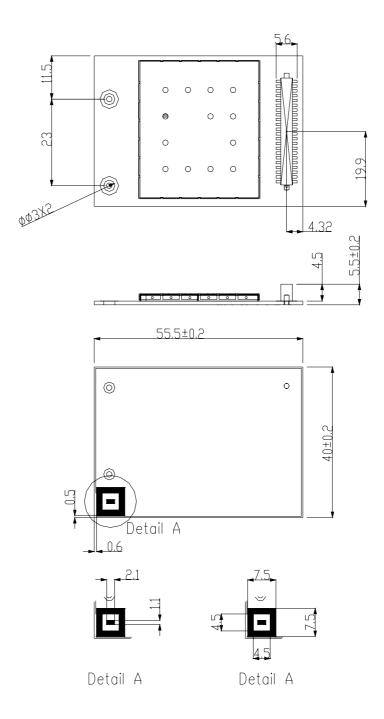
M33 Top View & Bottom View







Physical Dimension





Recommended PCB Layout

